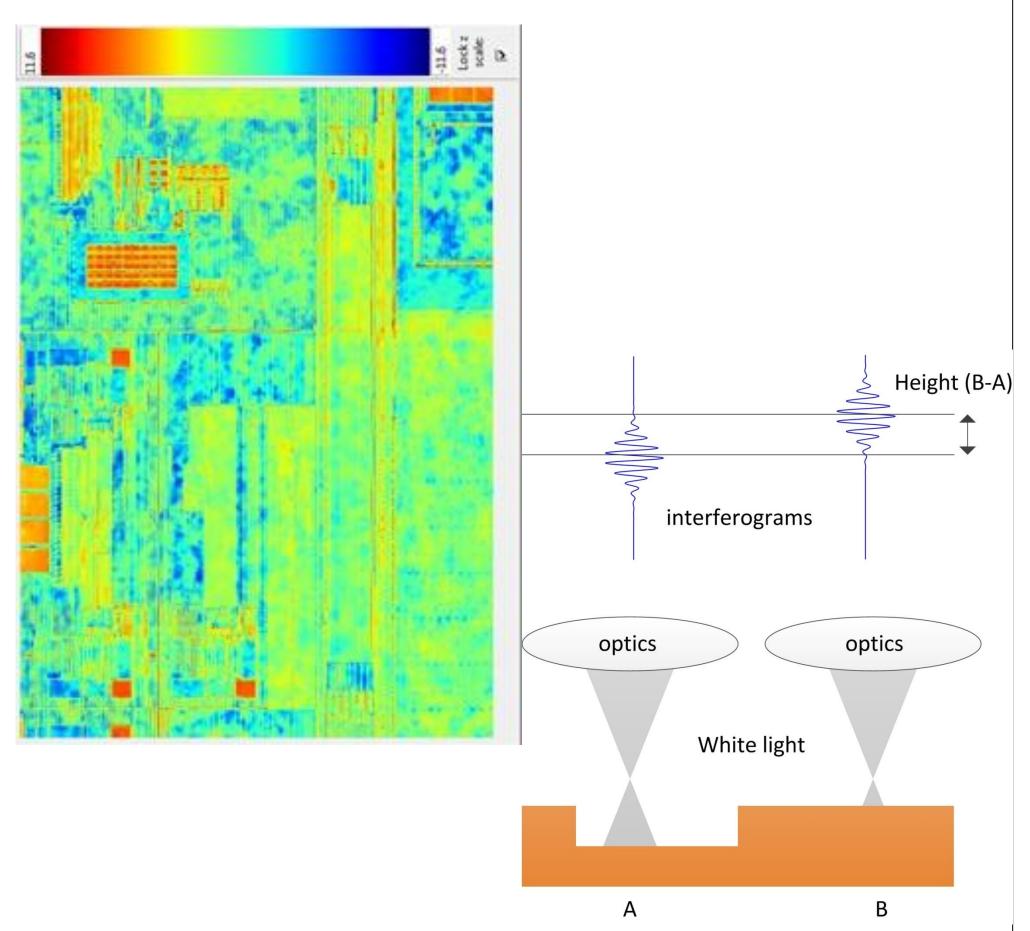
Analyzing Post-CMP Surface Topography from White Light Interference Microscopy

Introduction

The key metric for a successful CMP process is the planarity. Parameters of interest to planarity are tracked for statistical process control (SPC) to keep the process optimized.

The Unifire tool in Fab8 is based on interference microscopy, also called scanning white-light interferometry, and is a technique especially suited for CMP [1-2] because of its ability to measure topography with its large (~mm) area field of view with high spatial (~um per pixel) resolution. The output is an image topography height map. Images can be stitched to produce a full die topography map.



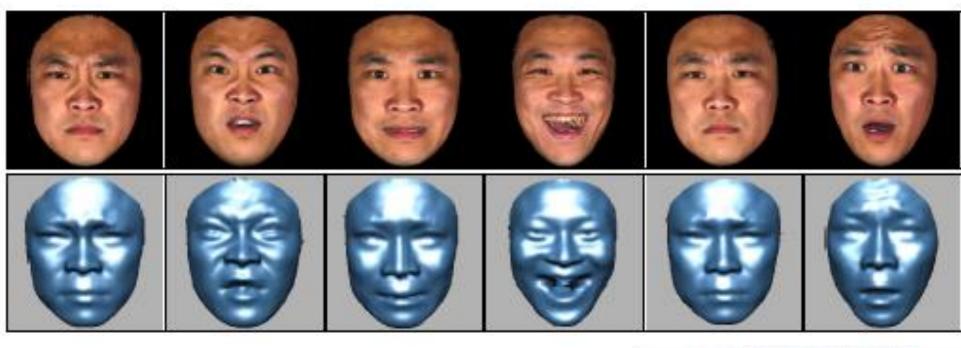
Statistics such as the average height, the height distribution, the kurtosis are output parameters which could be tracked for SPC. In this study the topography maps are analyzed beyond the traditional calculations for height average and distribution.

What does facial recognition have to do with post-CMP topography maps? A.F. Bello, Jusang Lee, Shinichiro Kakita, Nicholas Pieniazek Advanced Module Engineering, GLOBALFOUNDRIES, 400 Stone break Extension, Malta, NY, 12020, USA

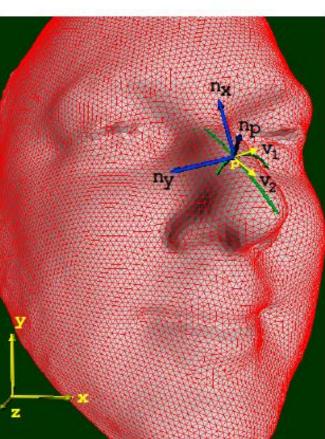
Methods

Surface map analysis [3-4] traditionally used in other fields such as image recognition, facial recognition, and geographical terrain topography are applied to the post-CMP surface topography measurements.

- In Geography, the terrain is classified \bullet according to the altitude and slope.
- The motivation is to determine the flow rates of water and sediment and how best to predict drainage.
- In Facial Recognition, the surfaces are primitive classified according to characteristics.



From Ref. [4]



Basic algorithm:

- Divide the topography map into small patches, in this case 7x7 pixels.
- Fit the 7x7 pixels to a surface.
- Calculate characteristics of the surface patch, e.g. gradient, 2nd derivative, amplitude of each.
- Classify each surface patch according to the characteristics.

Input\Output	Anger	Disgust	Fear	Happiness	Sadness	Surprise
Anger	80.0%	1.7%	6.3%	0.0%	11.3%	0.8%
Disgust	4.6%	80.4%	4.2%	3.8%	6.7%	0.4%
Fear	0.0%	2.5%	75.0%	12.5%	7.9%	2.1%
Happiness	0.0%	0.8%	3.8%	95.0%	0.4%	0.0%
Sadness	8.3%	2.5%	2.9%	0.0%	80.4%	5.8%
Surprise	1.7%	0.8%	1.2%	0.0%	5.4%	90.8%
	From Ref. [4]					

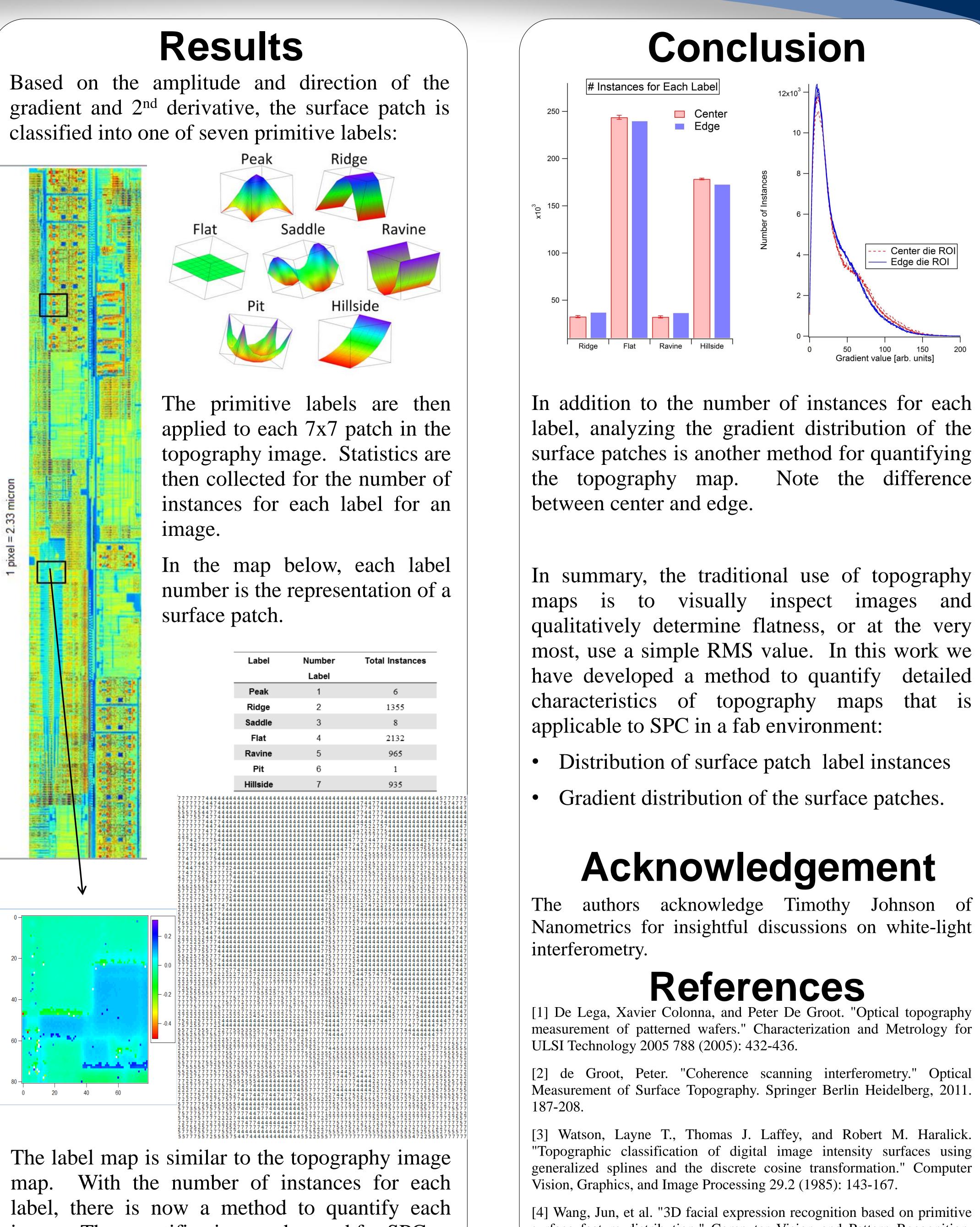


image. The quantification can be used for SPC.

surface feature distribution." Computer Vision and Pattern Recognition, 2006 IEEE Computer Society Conference on. Vol. 2. IEEE, 2006.

